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Should be replaced with:

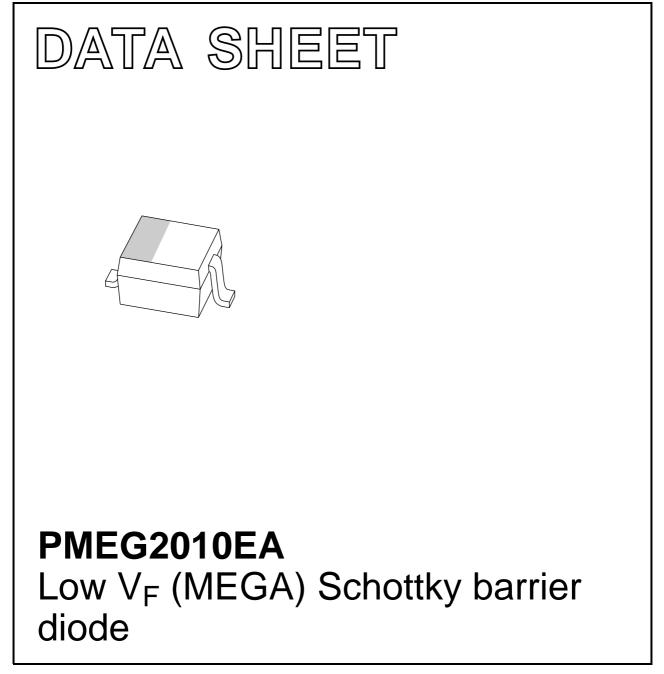
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2002 Dec 10 2004 Feb 06



FEATURES

- Forward current: 1 A
- Reverse voltage: 20 V
- Ultra high-speed switching
- Very low forward voltage
- Very small plastic SMD package.

APPLICATIONS

- Ultra high-speed switching
- Voltage clamping
- Protection circuits.

DESCRIPTION

Planar Maximum Efficiency General Application (MEGA) Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a SOD323 (SC-76) very small SMD plastic package.

ORDERING INFORMATION

TYPE		PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION	
PMEG2010EA	_	plastic surface mounted package; 2 leads	SOD323	

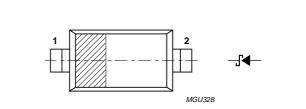
LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		-	20	V
I _F	continuous forward current		-	1	А
I _{FSM}	non-repetitive peak forward current	t _p = 8.3 ms half sinewave; JEDEC method	-	5	A
T _{stg}	storage temperature		-65	+150	°C
Тj	junction temperature		-	125	°C
T _{amb}	operating ambient temperature		-65	+125	°C

PINNING

PIN	DESCRIPTION
1	cathode
2	anode



Marking code: E1. The marking bar indicates the cathode.

Fig.1 Simplified outline (SOD323; SC-76) and symbol.

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	continuous forward voltage	see Fig.2; note 1			
		I _F = 10 mA	240	270	mV
		I _F = 100 mA	300	350	mV
		I _F = 1000 mA	480	550	mV
I _R	continuous reverse current	see Fig.3; note 1			
		$V_R = 5 V$	5	10	μΑ
		V _R = 8 V	7	20	μΑ
		V _R = 15 V	10	50	μA
C _d	diode capacitance	$V_R = 5 V$; f = 1 MHz; see Fig.4	19	25	pF

Note

1. Pulsed test: t_p = 300 µs; δ = 0.02.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	220	K/W
		note 2	180	K/W

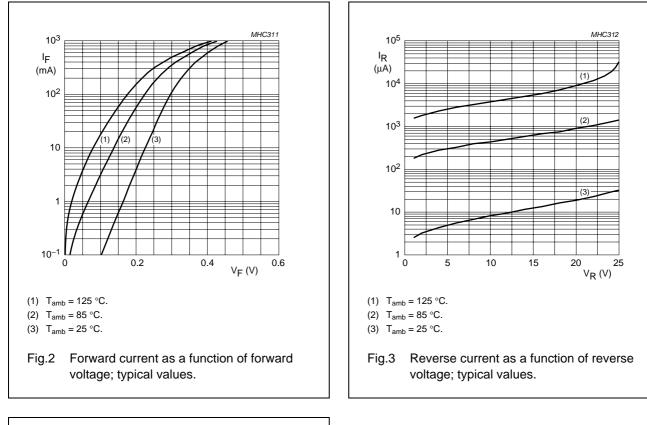
Notes

1. Device mounted on an FR4 printed-circuit board with Cu clad 10 x 10 mm.

2. Device mounted on an FR4 printed-circuit board with Cu clad 40 x 40 mm.

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GRAPHICAL DATA



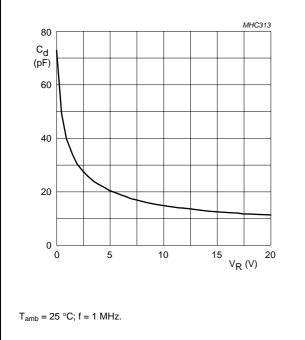
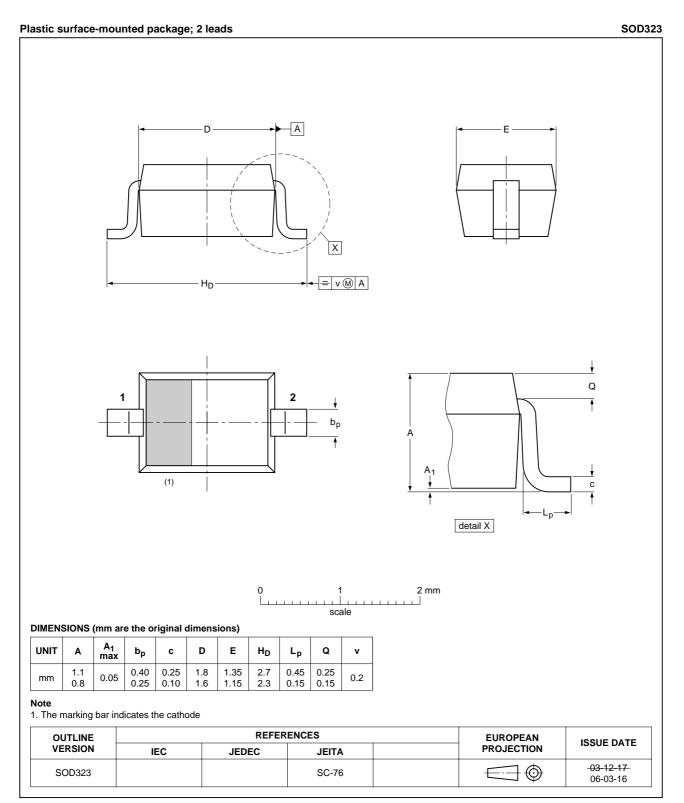


Fig.4 Diode capacitance as a function of reverse voltage; typical values.

PACKAGE OUTLINE



PMEG2010EA

PMEG2010EA

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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